



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 2835
Examiner: M. Datskovskiy

In Re PATENT APPLICATION OF:

Applicant: Seiji ANDOH)

Serial No.: 09/376,063)

Filed: August 17, 1999)

For: PACKAGE STRUCTURE FOR A)
SEMICONDUCTOR DEVICE)

Attorney Ref: OKI 226)

**SUBMISSION
PURSUANT TO
37 CFR 1.114**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This paper is submitted with the Applicant's Request for Continued Examination (RCE) pursuant to 37 C.F.R. §1.114. In satisfaction of the requirement to provide a submission with the RCE, the Applicant hereby incorporates by reference the arguments contained in the Appeal Brief filed April 23, 2004 and the Reply Brief filed September 10, 2004, the same to be considered as though fully set forth herein. See MPEP 706.07(h).

The Applicant also requests consideration of the Information Disclosure Statement (IDS) of even date submitted herewith, in conjunction with the continued examination of the application.

Respectfully submitted,



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February 18, 2005
Date

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**INFORMATION
DISCLOSURE
STATEMENT**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This is an information disclosure statement submitted in compliance with the requirements of 37 C.F.R. §1.98, and in conjunction with a Request for Continued Examination (RCE) of even date submitted pursuant to 37 C.F.R. §1.114.

Attached is a copy of a Japanese publication with an English-language translation from which the relevance of the publications may be gleaned. The publication is listed on the attached Form PTO-1449.

The listed publication (JP08-70062) was cited in a communication dated March 31, 2004 from the Japanese Patent Office in connection with a counterpart Japanese application. A copy of the foreign patent office communication together with an English translation is also attached. The Applicant advises that a second publication cited in the communication from the Japanese Patent Office (JP08-55933) is the same as Bond et al.

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(USP5,642,261), which has been previously been cited and fully considered by the Examiner.

Consideration of the submitted publication is respectfully requested.

Respectfully submitted,

February 17, 2005

Date



Phillip G. Avruch - Reg. No. 46, 076

RABIN & BERDO, P.C.

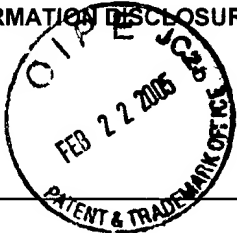
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Attachments

FORM PTO-1449 INFORMATION DISCLOSURE STATEMENT		Atty Docket <div style="text-align: center;">OKI 226</div>		Application No. <div style="text-align: center;">09/376,063</div>			
		Applicant <div style="text-align: center;">Seiji ANDOH</div>					
		Filing Date <div style="text-align: center;">August 17, 1999</div>		Group Unit <div style="text-align: center;">2835</div>			
U.S. PATENT DOCUMENTS							
Examiner Initial		Document Number	Date	Name	Class	Sub-Class	Filing Date
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
FOREIGN PATENT DOCUMENTS							
		Document Number	Date	Country	Class	Sub-Class	Translation
	AL	JP08-70062	3/12/1996	Japan			Yes
	AM						
	AN						
	AO						
OTHER (Including Author, Title, Date, Pertinent Pages, etc.)							
	AP						
	AQ						
	AR						
Examiner					Date Considered		
EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.							